

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1061	anisotropic near etching and posts and contact	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 10:02
L2	222	anisotropic adj etching and posts and contact and IC	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/01 10:02
L3	24	("4785763"   "4889588"   "4902377"   "5188704"   "5232747"   "5258093"   "5492855"   "5498768"   "5515984"   "5527729"   "5554866"   "5565036"   "5658820"   "5679213"   "5686339"   "5696018"   "5707487"   "5753044"   "5792593"   "5854104"   "5907791"   "6090717"   "6165816"   "6171977"). PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/03/01 10:08
S18 1	1	anistropic adj conductive near substrate	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 16:14
S18 2	2	US-6344156-\$.DID.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 15:22
S18 3	22	anistropic near substrate	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 13:48
S18 4	20	US-4307505-\$.DID. OR US-5469613-\$.DID. OR US-5647119-\$.DID. OR US-5934137-\$.DID. OR US-5983489-\$.DID. OR US-6293004-\$.DID. OR US-6591487-\$.DID. OR US-6594888-\$.DID. OR US-6671944-\$.DID. OR US-6708396-\$.DID.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 15:41
S18 5	2	"6344156".pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 16:03
S18 6	5	("4740657"   "5336443"   "6034331"). PN. OR ("6344156").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/27 16:04
S18 7	81	("4740657").URPN.	USPAT	OR	ON	2006/02/27 16:14

## EAST Search History

S188	37	anistropic near conductive and substrate	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 16:16
S189	1	29/830.ccls. and anistropic	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 16:19
S190	1	Hsinchu.inv.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 16:31
S191	103	semiconductor near substrate and pins and back near plate	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 16:31
S192	12	semiconductor near substrate and pins and liquid adj compound and plate	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 16:41
S193	0	substrate and pins and liquid adj compound and back near holder	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/27 16:43
S194	33	substrate and pins and compound and back near holder	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 07:34
S219	1283	anisotropic near substrate	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 13:48
S220	43	anisotropic near etching and posts and fill\$3 near spaces	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 13:51
S221	8	anisotropic near etching and posts and fill\$3 near spaces and insulation	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 13:52
S222	1296	substrate and anisotropic near etching and posts	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 13:59
S223	1274	substrate and anisotropic adj etching and posts	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 13:59

## EAST Search History

S22 4	22	substrate and anisotropic adj etching and posts and S223/\$.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:01
S22 5	123	substrate and anisotropic adj etching and posts and LSI	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:01
S22 6	6	("4659649"   "5064741"   "5229254"   "5256522"   "5332648"   "5364734").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/28 14:10
S22 7	24	"DID." OR US-5473120-\$.DID. OR US-5883335-\$.DID. OR US-6036566-\$.DID. OR US-6096656-\$.DID. OR US-6465950-\$.DID. OR US-4706167-\$.DID. OR US-5541368-\$.DID. OR US-6258286-\$.DID. OR US-6199273-\$.DID. OR US-6207259-\$.DID. OR US-6242078-\$.DID. OR US-6245996-\$.DID.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:22
S22 8	682	anisotropic adj etching and conductive near substrate	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:31
S22 9	1	("6614069").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/28 14:28
S23 0	53	anisotropic adj etching and conductive near substrate and post	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:34
S23 1	49	Kiyokazu near Moriizumi.inv.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:44
S23 2	2	"5916453".pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:44

## EAST Search History

S23 3	55	("4181755"   "4307179"   "4622058"   "4634496"   "4795722"   "4824521"   "4954142"   "4981553"   "5006485"   "5084071"   "5091339"   "5098517"   "5118385"   "5137597"   "5162260"   "5169491"   "5217586"   "5219793"   "5225034"   "5244534"   "5246884"   "5258096"   "5272117"   "5284548"   "5287619"   "5298463"   "5302551"   "5314843"   "5328553"   "5332467"   "5350712"   "5354490"   "5354712"   "5356513"   "5363550"   "5380546"   "5389194"   "5397741"   "5429987"   "5451543"   "5451551"   "5453402"   "5491113").PN. OR ("5916453").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/28 14:49
S23 4	2	"4968585".pn.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:52
S23 5	4	pcb and post near structure and etching and polishing	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:55
S23 6	20	US-5286926-\$.DID. OR US-6028364-\$. DID. OR US-5331514-\$.DID. OR US-5987744-\$.DID. OR US-5135606-\$. DID. OR US-5454161-\$.DID.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/28 14:55
S23 7	4	("4604160"   "4814040"   "4926549"   "5058800").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/28 15:01
S23 8	54	("3181986"   "4306925"   "4354895"   "4465538").PN. OR ("4604160").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/03/01 10:01